# 103166-3 ACTIVE

## AMPMODU | AMPMODU Headers

TE Internal #: 103166-3

PCB Mount Header, Right Angle, Wire-to-Board / Board-to-Board, 10 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold,

AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles

PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board, Wire-to-Board

Number of Positions: 10

Number of Rows: 2

## **Features**

# **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board, Wire-to-Board
Header Type	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board

## **Configuration Features**

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Right Angle
Number of Positions	10
Number of Rows	2

## **Electrical Characteristics**

Insulation Resistance	5000 MΩ
Dielectric Withstanding Voltage (Max)	750 Vrms

## **Body Features**

Connector Profile	Standard
Primary Product Color	Black

#### **Contact Features**

Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Shape & Form	Square
Contact Underplating Material	Nickel



DCD Contact Tarmination Area Plating Material	Tip Load
PCB Contact Termination Area Plating Material  Contact Base Material	Phonbor Propze
	Phosphor Bronze  Gold
Contact Mating Area Plating Material	
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.43 mm[.135 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Retention	With
Mating Retention Type	Detent Window
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.4 mm[.055 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Agency/Standard	CSA



Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	160
Packaging Type	Tray

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2022 (224) SVHC > Threshold: Pb (40% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 240°C

## Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



TE Part # 3-87977-0 TE Part # 5-534206-5 TE Part # 87977-3 10 MODIV HSG COMP DR .100 POL 10 MODII VRT DR CE 100/115 10 MODIV HSG DR MRKD .100 POL Also in the Series | AMPMODU Headers PCB Connector Mounting(1) PCB Connector Shrouds(1) PCB Headers & Receptacles(4875) PCB Latches, Locks & Retainers(1) Wire-to-Board Connector Assemblies Wire-to-Board Connector Contacts(65) & Housings(5) Customers Also Bought TE Part #103906-3 TE Part #6-104069-2 TE Part #5-103166-2 TE Part #5-102617-8 04 MTE HDR SRRA LATCH .100CL 24 sys 50 hdr drra shrd sn 08 MODII HDR DRRA SHRD LF 20 MODII HDR DRRA SHRD LF TE Part #103906-1 TE Part #103906-2 TE Part #2342934-1 TE Part #103169-3 03 MTE HDR SRRA LATCH .100CL 02 MTE HDR SRRA LATCH .100CL QSFP-DD 1X1, STANDARD, W/ 10 MODII HDR DRST SHRD .100CL ZIPPER HS



TE Part #2325864-1

SFP-DD RECEPTACLE ASSEMBLY

TE Part #2359845-1

CAGE ASSY W/ HS,SFP-DD 1X1,

GENERAL

## **Documents**

## **Product Drawings**

10 MODII HDR DRRA SHRD .100CL

English

### **CAD Files**

3D PDF

English

**Customer View Model** 

ENG\_CVM\_103166-3\_K.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_103166-3\_K.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_103166-3\_K.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

# Datasheets & Catalog Pages

AMPMODU Interconnetion System

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English